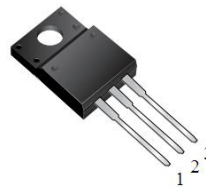
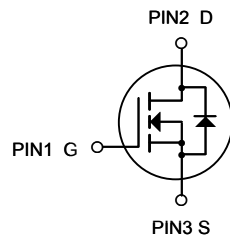
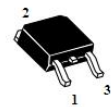


### FEATURE

- 4A,650V, $R_{DS(ON)MAX}=2.6\ \Omega$  @ $V_{GS}=10V/2A$
- Low gate charge
- Low  $C_{iss}$
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



ITO-220AB  
4N65F



TO-252  
4N65

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.  
Single phase half wave, 60Hz, resistive or inductive load.

Absolute Maximum Ratings( $T_c=25^\circ\text{C}$ , unless otherwise noted)			
Parameter	Symbol	4N65	UNIT
Drain-Source Voltage	$V_{DSS}$	650	V
Gate-Source Voltage	$V_{GSS}$	$\pm 30$	
Continuous Drain Current	$I_D$	4	A
Pulsed Drain Current(Note1)	$I_{DM}$	16	
Single Pulse Avalanche Energy (Note 2)	$E_{AS}$	150	mJ
Reverse Diode dV/dt (Note 3)	dv/dt	2.63	V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	$T_L$	260	°C
Mounting Torque	6-32 or M3 screw	10	lbf • in
		1.1	N • m

## RATING AND CHARACTERISTIC CURVES (4N65)

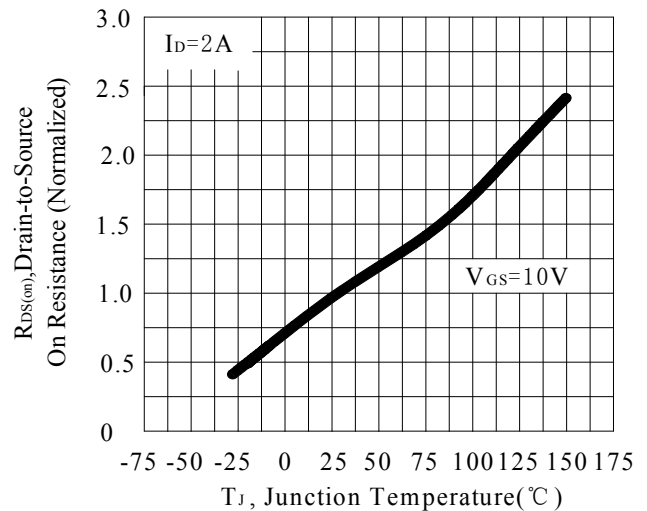
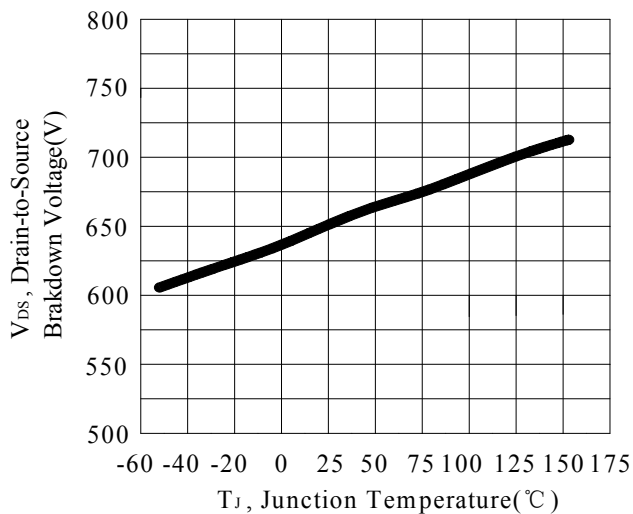
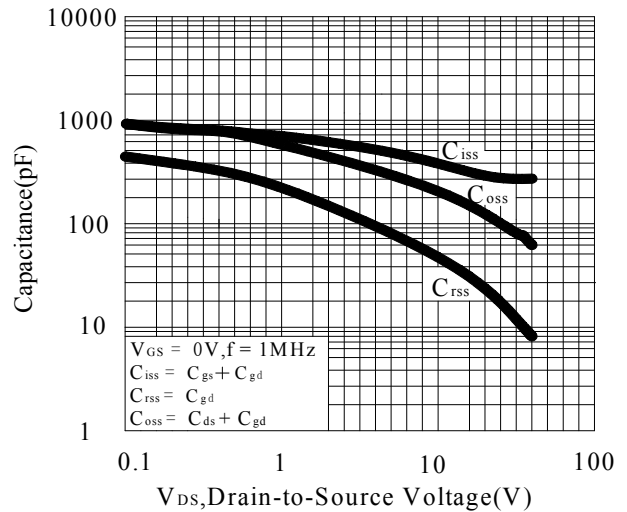
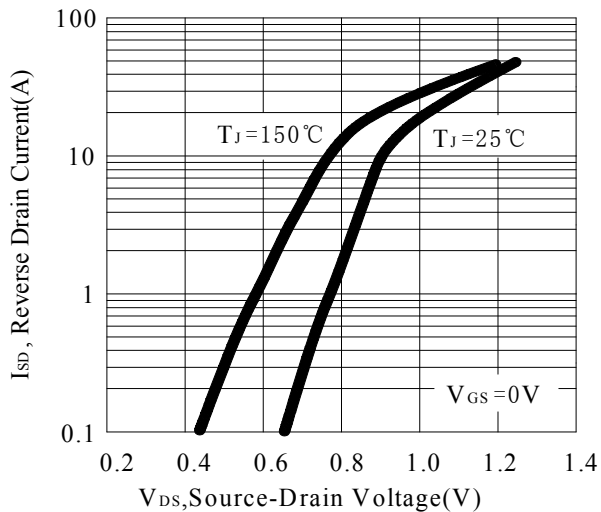
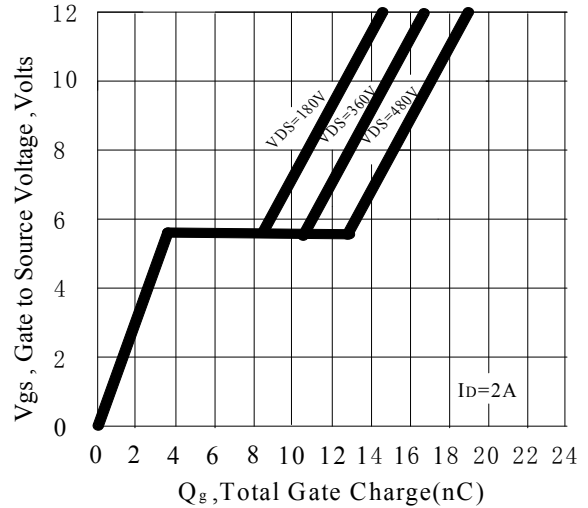
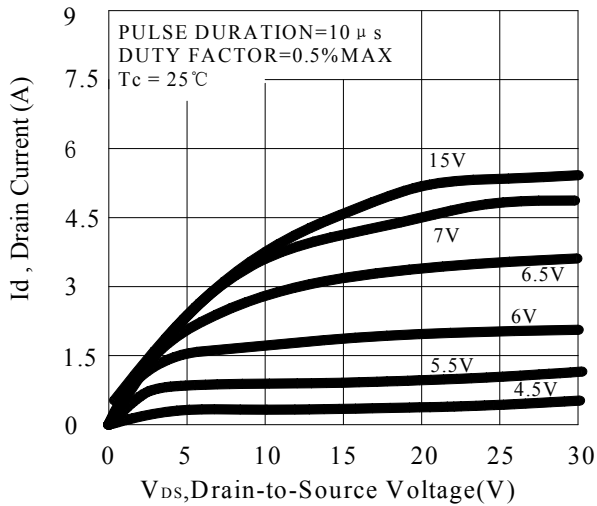
Thermal Characteristics						
Parameter		Symbol	MAX	Units		
Maximum Junction-to-Case		$R_{thJC}$	3.47	°C/W		
Maximum Power Dissipation	$T_c=25^\circ\text{C}$	$P_D$	34	W		

Electrical Characteristics ( $T_c=25^\circ\text{C}$ , unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	650	—	—	V
Breakdown Temperature Coefficient	$\Delta BV_{DSS} / \Delta T_J$	Reference to $25^\circ\text{C}$ , $I_D=250\mu A$	—	0.67	—	V/°C
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V$	—	—	10	$\mu A$
Gate-Body Leakage Current, Forward	$I_{GSSF}$	$V_{GS}=30V, V_{DS}=0V$	—	—	100	nA
Gate-Body Leakage Current, Reverse	$I_{GSSR}$	$V_{GS}=-30V, V_{DS}=0V$	—	—	-100	nA
<b>On Characteristics</b>						
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	—	4	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=2A$	—	2.1	2.6	$\Omega$
Pulse width $t_p \leq 380\mu s, \delta \leq 2\%$						
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V,$	—	425	—	pF
Output Capacitance	$C_{oss}$	$f=1.0\text{MHZ}$	—	55	—	pF
Reverse Transfer Capacitance	$C_{rss}$		—	5.8	—	pF
<b>Switching Characteristics</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=325V, I_D=4A,$	—	10	—	ns
Turn-On Rise Time	$t_r$	$R_G=10\Omega$	—	11	—	ns
Turn-Off Delay Time	$t_{d(off)}$	(Note3,4)	—	31	—	ns
Turn-Off Fall Time	$t_f$		—	16	—	ns
Total Gate Charge	$Q_g$	$V_{DS}=325V, I_D=4A,$	—	14.5	—	nC
Gate-Source Charge	$Q_{gs}$	$V_{GS}=10V$ (Note3,4)	—	3	—	nC
Gate-Drain Charge	$Q_{gd}$		—	6	—	nC
<b>Drain-Source Body Diode Characteristics and Maximum Ratings</b>						
Diode Forward Voltage	$V_{SD}$	$I_S=4A, V_{GS}=0V$	—	—	1.5	V
Reverse Recovery Time	$t_{rr}$	$V_{GS}=0V, I_S=4A, T_J=25^\circ\text{C}$	—	320	—	ns
Reverse Recovery Charge	$Q_{rr}$	$di_F/dt=100A/\mu s$ (Note3)	—	2.0	—	nC
Pulse width $t_p \leq 380\mu s, \delta \leq 2\%$						

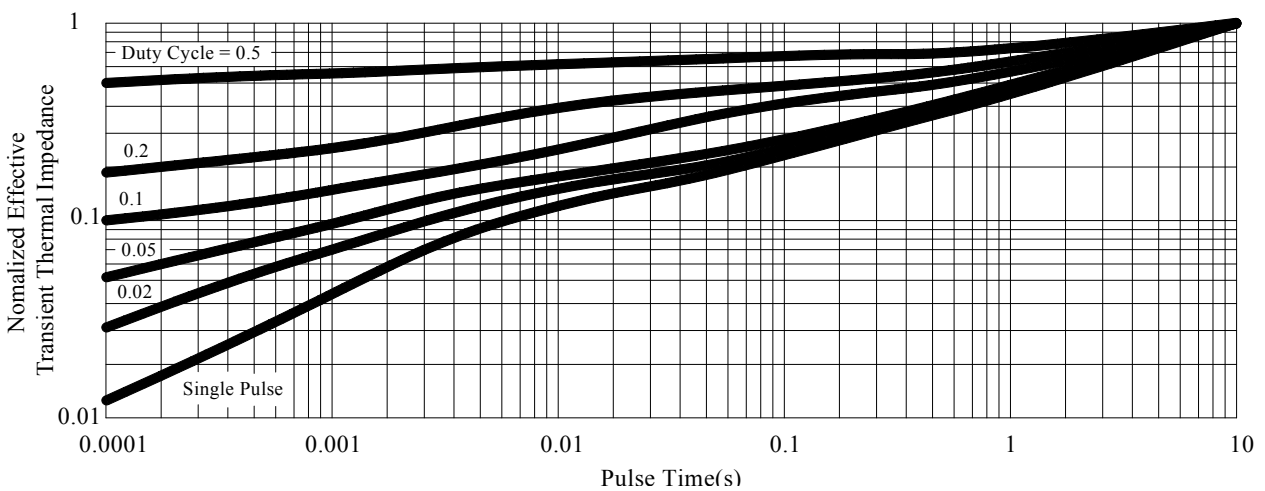
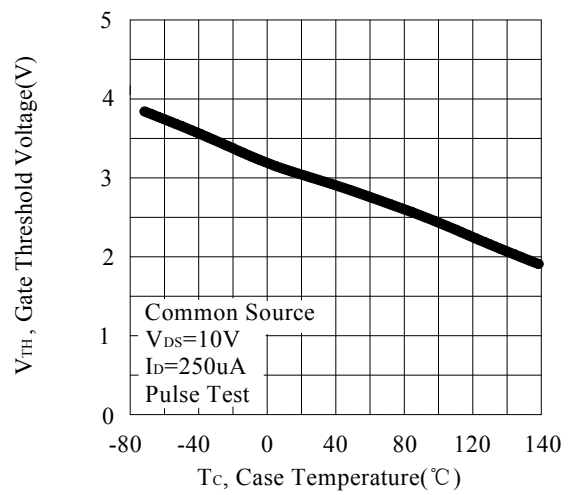
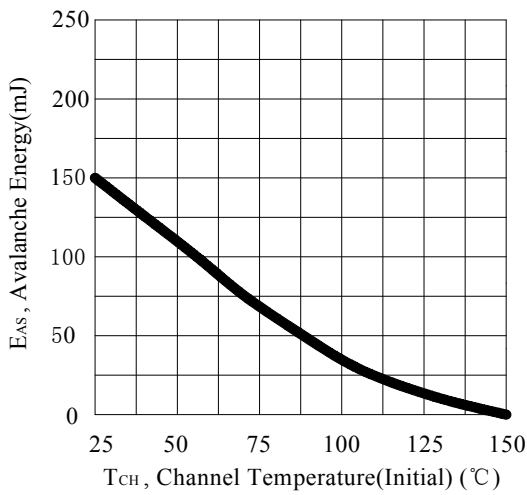
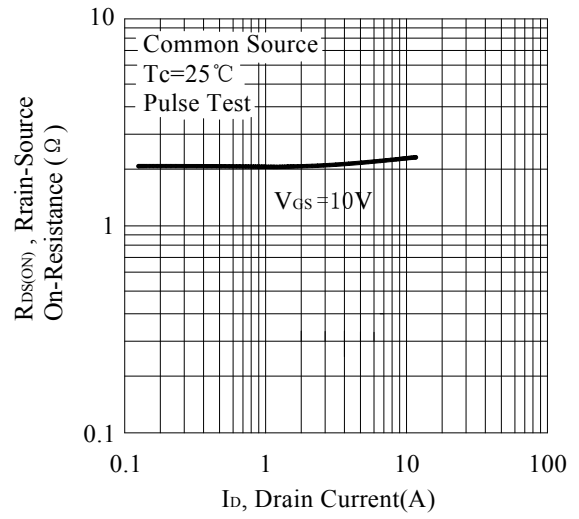
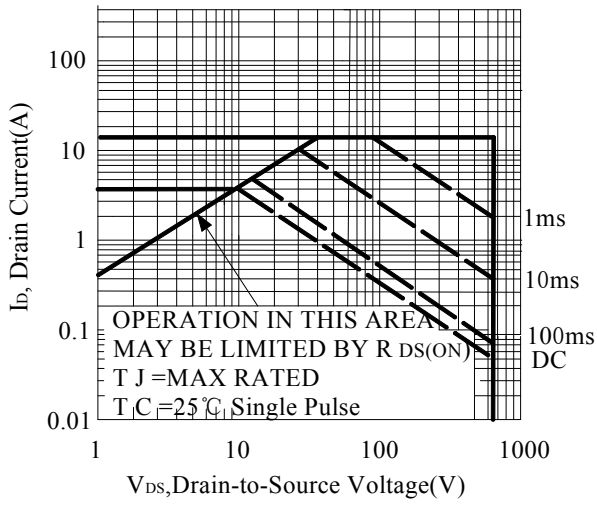
### Notes

1. Repetitive Rating: pulse width limited by maximum junction temperature .
2.  $V_{DD}=50V, L=18.8\text{mH}, R_g=25\Omega, I_{AS}=4A, T_J=25^\circ\text{C}$ .
3.  $di/dt= \_A/\mu s, T_J=25^\circ\text{C}$ . Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$ .
4. Repetitive rating; pulse width limited by maximum junction temperature.

## RATING AND CHARACTERISTIC CURVES (4N65)



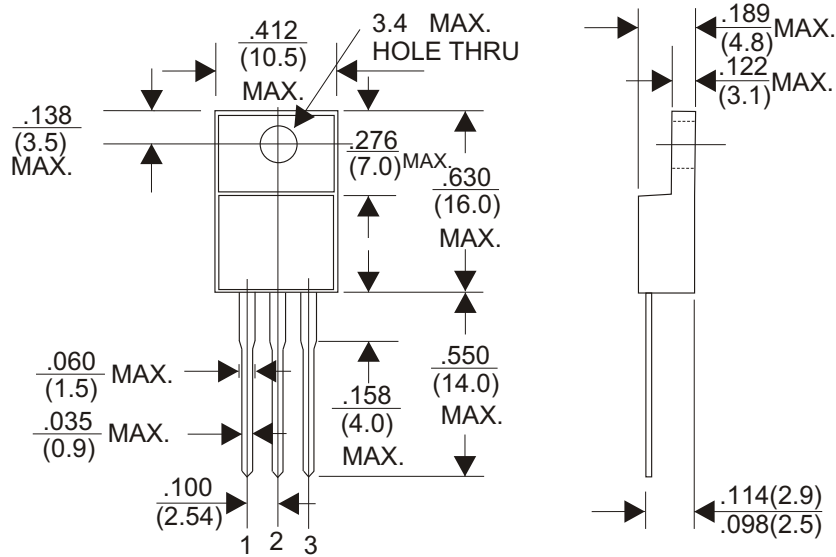
## RATING AND CHARACTERISTIC CURVES (4N65)





RATING AND CHARACTERISTIC CURVES (4N65)

**ITO-220 Mechanical Drawing**



**TO-252 Mechanical Drawing**

Unit: mm

